TOSHIBA Field Effect Transistor Silicon P Channel MOS Type

SSM3J120TU

○ Power Management Switch Applications

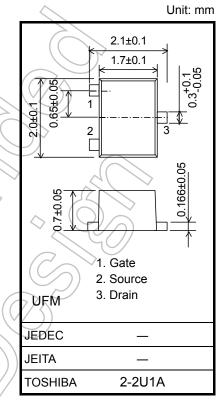
○ High-Current Switching Applications

- 1.5 V drive
- Low on-resistance
 - $R_{on} = 140 \text{ m}\Omega \text{ (max)} (@V_{GS} = -1.5 \text{ V})$
 - $R_{on} = 78 \text{ m}\Omega \text{ (max)} (@V_{GS} = -1.8 \text{ V})$
 - $R_{on} = 49 \text{ m}\Omega \text{ (max)} (@V_{GS} = -2.5 \text{ V})$
 - R_{on} = 38 m Ω (max) (@V_{GS} = -4.0 V)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-Source voltage		V _{DS}	-20	V
Gate-Source voltage		V _{GSS}	± 8	× /
Drain current	DC	I _D	-4.0	
	Pulse	I _{DP}	-8.0	$(\sqrt{2})$
Drain power dissipation		P _D (Note 1)	800	
		P _D (Note 2)	500	mW
Channel temperature		T _{ch}	150	> °C
Storage temperature		T _{stg}	-55~150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.



Weight: 6.6mg (typ.)

Please design the appropriate reliability upon reviewing the

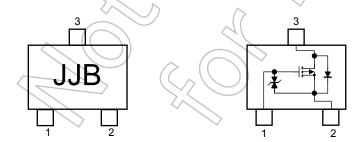
Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 1 : Mounted on ceramic board
- $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 0.8 \text{ t}, \text{ Cu Pad: } 645 \text{ mm}^2)$ Note 2 : Mounted on FR4 board

(25.4 mm imes 25.4 mm imes 1.6 t, Cu Pad: 645 mm²).

Marking

Equivalent Circuit (top view)

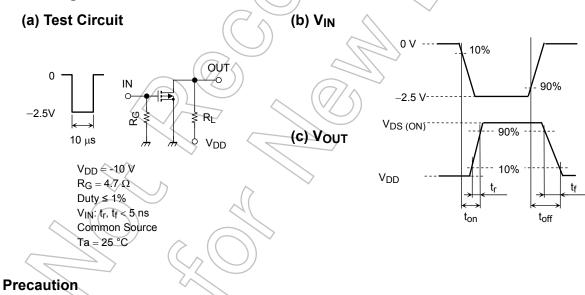


Electrical Characteristics (Ta = 25°C)

Charao	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain-Source breakdown voltage		V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0$	-20		_	V
		V (BR) DSX	$I_D = -1 \text{ mA}, V_{GS} = +8 \text{ V}$	-12		—	
Drain cut-off curre	ent	I _{DSS}	$V_{DS} = -20 V, V_{GS} = 0$			-10	μA
Gate leakage curr	ent	I _{GSS}	$V_{GS}=\pm 8~V,~V_{DS}=0$	$\langle \langle \rangle$		±1	μA
Gate threshold vo	Itage	V _{th}	$V_{DS} = -3 V, I_D = -1 mA$	-0.3	/	-1.0	V
Forward transfer a	admittance	Y _{fs}	$V_{DS} = -3 V, I_D = -2.0 A$ (Note 3)	6.1	12.1	_	S
Drain-Source ON-resistance		$I_D = -3.0 \text{ A}, V_{GS} = -4.0 \text{ V}$ (Note 3)		28	38	mΩ	
	D	$I_D = -2.0 \text{ A}, V_{GS} = -2.5 \text{ V}$ (Note 3)	V/2	34	49		
	R _{DS} (ON)	$I_D = -1.0 \text{ A}, V_{GS} = -1.8 \text{ V}$ (Note 3)	\square	47	78		
		$I_D = -0.3 \text{ A}, V_{GS} = -1.5 \text{ V}$ (Note 3)	$\left \right\rangle$	60	140		
Input capacitance		C _{iss}		2-	1484	-	pF
Output capacitance		C _{oss}	$V_{DS} = -10 V, V_{GS} = 0$	_	185	Ĥ	pF
Reverse transfer capacitance		C _{rss}		_	169		pF
Switching time	Turn-on time	t _{on}	$V_{DD} = -10 \text{ V}, \text{ I}_{D} = -2.0 \text{ A}$ $V_{GS} = 0 \text{ to } -2.5 \text{ V}, \text{ R}_{G} = 4.7 \Omega$	~- (67		ns
	Turn-off time	t _{off}		\sim	92	\mathcal{D}	
Total gate charge		Qg		7	22,3	/_	nC
Gate-Source charge		Qgs	$V_{DS} = -16 V$, $I_{DS} = -4.0 A$, $V_{GS} = -4.0 V$,	Ó	14.9	_	
Gate-Drain charge		Q _{gd}	VGS+.0 V,		7.3	—	
Drain-Source forward voltage VDSF		V _{DSF}	$I_D = 4.0 \text{ A}, V_{GS} = 0$ (Note 3)	D)	0.8	1.2	V

Note 3: Pulse test

Switching Time Test Circuit

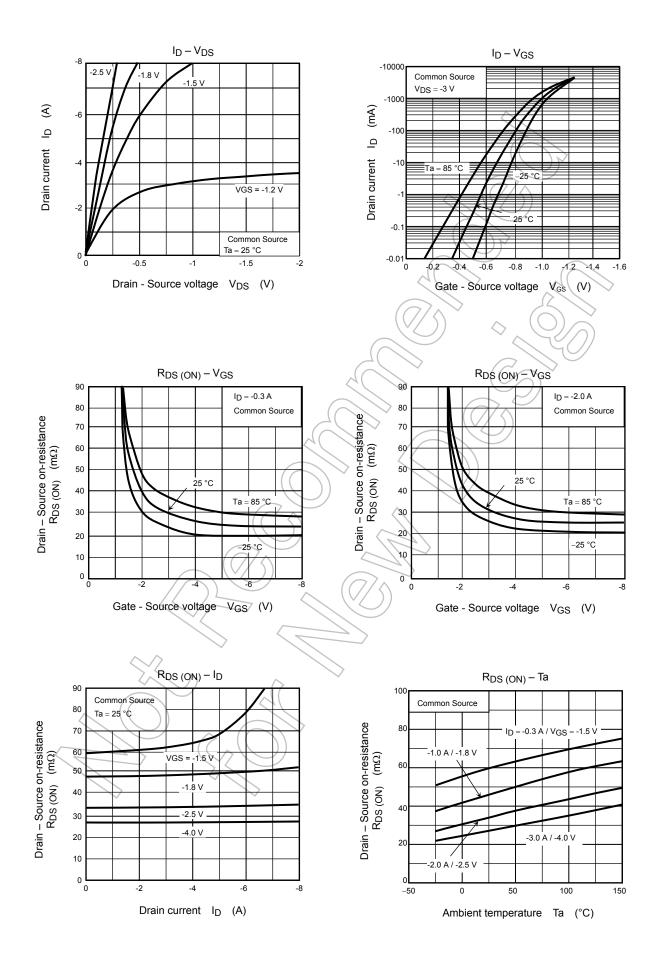


 V_{th} can be expressed as the voltage between the gate and source when the low operating current value is $I_D = -1$ mA for this product. For normal switching operation, V_{GS} (on) requires a higher voltage than V_{th} and V_{GS} (off) requires a lower voltage than V_{th} . (The relationship can be established as follows: V_{GS} (off) < V_{th} < V_{GS} (on).) Be sure to take this into consideration when using the device.

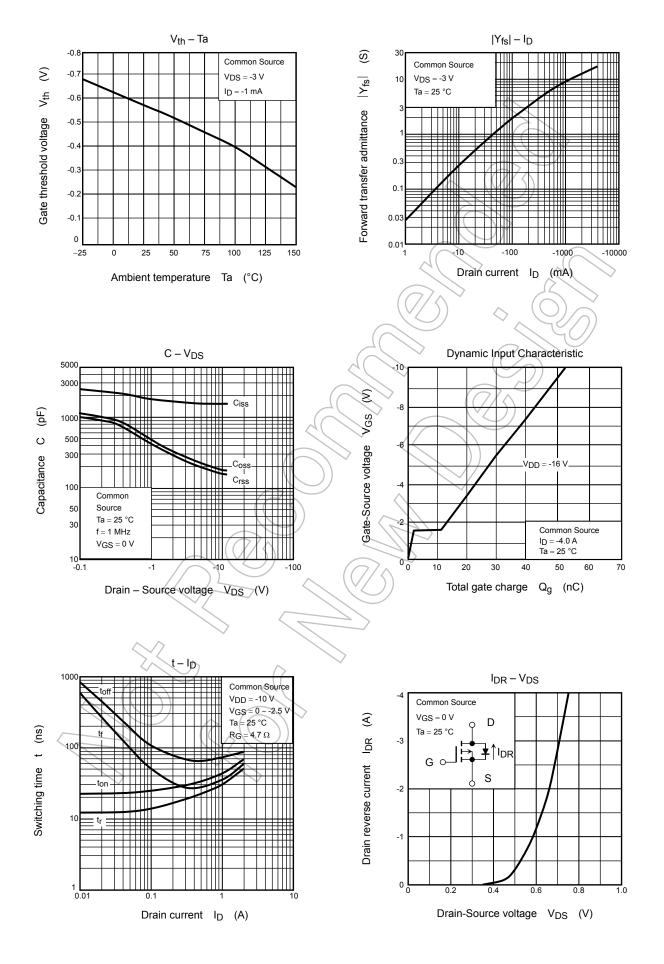
Handling Precaution

When handling individual devices (which are not yet mounted on a circuit board), ensure that the environment is protected against static electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

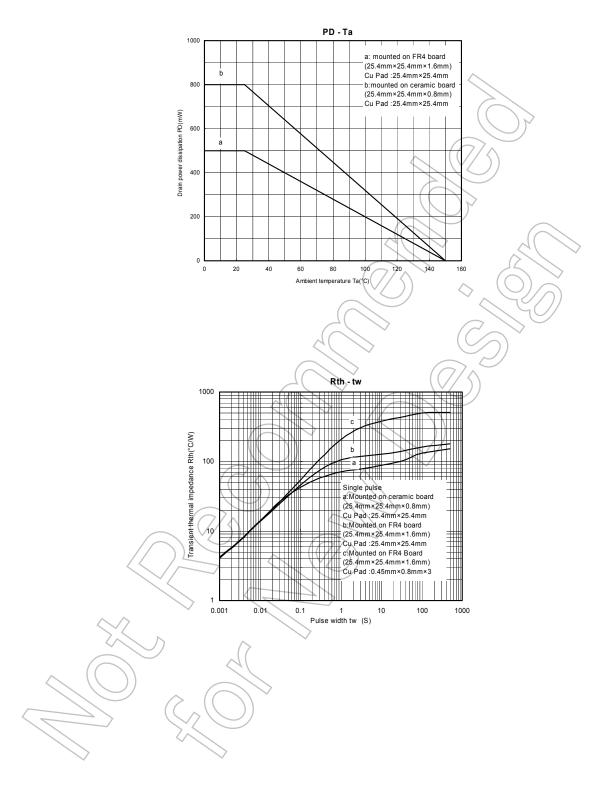
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